

NC7WZ17

TinyLogic® UHS Dual Buffer with Schmitt Trigger Inputs

General Description

The NC7WZ17 is a dual buffer with Schmitt trigger inputs from Fairchild's Ultra High Speed Series of TinyLogic § in the SC70 6-lead package. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad $\rm V_{CC}$ operating range. The device is specified to operate over the 1.65V to 5.5V $\rm V_{CC}$ range. The inputs and outputs are high impedance when $\rm V_{CC}$ is 0V. Inputs tolerate voltages up to 7V independent of $\rm V_{CC}$ operating voltage. Schmitt trigger inputs typically achieve 1V hysteresis between the positive going and negative going input threshold voltage at 5V $\rm V_{CC}$.

Features

- Space saving SC70 6-lead package
- Ultra small MicroPak[™] Pb-Free leadless package
- Ultra high speed: t_{PD} 3.6ns Typ into 50pF at 5V V_{CC}
- High Output Drive: ±24mA at 3V V_{CC}
- Broad V_{CC} operating range: 1.65V to 5.5V
- \blacksquare Matches the performance of LCX when operated at 3.3V V_{CC}
- Power down high impedance inputs/outputs
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

Ordering Information

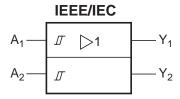
Order Number	Package Number	Package Code Top Mark	Package Description	Supplied As
NC7WZ17P6X	MAA06A	Z17	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7WZ17P6X_NL ⁽¹⁾	MAA06A	Z17	Pb-Free 6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7WZ17L6X	MAC06A	B5	Pb-Free 6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B.

Note:

1. "_NL" indicates Pb-Free product (per JEDEC J-STD-020B). Device is available in Tape and Reel only.

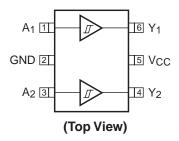
Logic Symbol



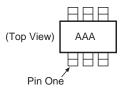
TinyLogic[®] is a registered trademark of Fairchild Semiconductor Corporation. MicroPak[™] is a trademark of Fairchild Semiconductor Corporation.

Connection Diagrams

Pin Assignment for SC70



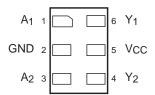
Pin One Orientation Diagram



AAA represents Product Code Top Mark – see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Through View)

Pin Descriptions

Pin Name	Description
A ₁ , A ₂	Data Inputs
Y ₁ , Y ₂	Outputs

Function Table

Y = A

Input	Output
Α	Υ
L	L
Н	Н

H = HIGH Logic Level L = LOW Logic Level

Absolute Maximum Ratings

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	−0.5V to +7V
V _{IN}	DC Input Voltage	−0.5V to +7V
V _{OUT}	DC Output Voltage	−0.5V to +7V
I _{IK}	DC Input Diode Current @ V _{IN} < -0.5V	-50mA
I _{OK}	DC Output Diode Current @ V _{OUT} < -0.5V	–50mA
I _{OUT}	DC Output Current	±50mA
I _{CC} /I _{GND}	DC V _{CC} /GND Current	±100mA
T _{STG}	Storage Temperature	−65°C to +150°C
T _J	Junction Temperature under Bias	150°C
T _L	Junction Lead Temperature (Soldering, 10 seconds)	260°C
P _D	Power Dissipation @ +85°C	180mW

Recommended Operating Conditions⁽²⁾

Symbol	Parameter	Rating
V _{CC}	Supply Voltage Operating	1.65V to 5.5V
V _{CC}	Supply Voltage Data Retention	1.5V to 5.5V
V _{IN}	Input Voltage	0V to 5.5V
V _{OUT}	Output Voltage	0V to V _{CC}
T _A	Operating Temperature	-40°C to +85°C
θ_{JA}	Thermal Resistance	350°C/W

3

Note:

2. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

							T _A =			
						+25°C		-40°C t	o +85°C	
Symbol	Parameter	Con	ditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Units
V _P	Positive			1.65	0.6	1.0	1.4	0.6	1.4	V
	Threshold			1.8	0.7	1.07	1.5	0.7	1.5	
	Voltage			2.3	1.0	1.38	1.8	1.0	1.8	
				3.0	1.3	1.74	2.2	1.3	2.2	
				4.5	1.9	2.43	3.1	1.9	3.1	
				5.5	2.2	2.88	3.6	2.2	3.6	
V _N	Netative			1.65	0.2	0.5	0.8	0.2	0.8	V
	Threshold			1.8	0.25	0.56	0.9	0.25	0.9	
	Voltage			2.3	0.40	0.75	1.15	0.40	1.15	
				3.0	0.6	0.98	1.5	0.6	1.5	
				4.5	1.0	1.42	2.0	1.0	2.0	
				5.5	1.2	1.68	2.3	1.2	2.3	
V _H	Hystersis			1.65	0.1	0.48	0.9	0.1	0.9	V
	Voltage			1.8	0.15	0.51	1.0	0.15	1.0	
				2.3	0.25	0.62	1.1	0.25	1.1	
				3.0	0.4	0.76	1.2	0.4	1.2	
				4.5	0.6	1.01	1.5	0.6	1.5	
				5.5	0.7	1.20	1.7	0.7	1.7	
V _{OH}	HIGH Level	V _{IN} = V _{IH}	I _{OH} = -100μA	1.65	1.55	1.65		1.55		V
	Output Voltage			1.8	1.7	1.8		1.7		
				2.3	2.2	2.3		2.2		
				3.0	2.9	3.0		2.9		
				4.5	4.4	4.5		4.4		
			I _{OH} = -4mA	1.65	1.29	1.52		1.29		
			I _{OH} = -8mA	2.3	1.9	2.14		1.9		
			I _{OH} = -16mA	3.0	2.4	2.75		2.4		
			I _{OH} = -24mA	3.0	2.3	2.62		2.3		
			I _{OH} = -32mA	4.5	3.8	4.13		3.8		
V _{OL}	LOW Level	$V_{IN} = V_{IL}$	I _{OL} = 100μA	1.65		0.0	0.1		0.1	V
	Output Voltage			1.8		0.0	0.1		0.1	
				2.3		0.0	0.1		0.1	
				3.0		0.0	0.1		0.1	
				4.5		0.0	0.1		0.1	
			I _{OL} = 4mA	1.65		0.08	0.24		0.24	
			I _{OL} = 8mA	2.3		0.10	0.3		0.3	
			I _{OL} = 16mA	3.0		0.16	0.4		0.4	
			I _{OL} = 24mA	3.0		0.24	0.55		0.55	
			$I_{OL} = 32mA$	4.5		0.25	0.55		0.55	

4 www.fairchildsemi.com

DC Electrical Characteristics (Continued)

				T _A =					
					+25°C		-40°C to	o +85°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Units
I _{IN}	Input Leakage Current	V _{IN} = 5.5V, GND	0 to 5.5			±0.1		±1.0	μA
l _{OFF}	Power Off Leakage Current	V_{IN} or $V_{OUT} = 5.5V$	0.0			1		10	μA
I _{CC}	Quiescent Supply Current	V _{IN} = 5.5V, GND	1.65 to 5.5			1.0		10	μA

AC Electrical Characteristics

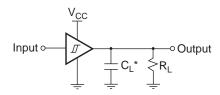
				T _A =						
					+25°C		-40°C t	o +85°C		Figure
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Units	Number
t _{PLH} , t _{PHL}	Propagation Delay	$C_L = 15pF$,	1.65	2.0	8.3	14.3	2.0	15.8	ns	Figure 1
		$R_L = 1M\Omega$	1.8	2.0	6.9	11.9	2.0	13.1		Figure 3
			2.5 ± 0.2	1.5	4.8	8.2	1.5	9.0		
			3.3 ± 0.3	1.0	3.7	5.6	1.0	6.2		
			5.0 ± 0.5	0.8	3.0	4.7	0.8	5.2		
		$C_L = 50pF,$	3.3 ± 0.3	1.5	4.3	6.6	1.5	7.3	ns	Figure 1
		$R_L = 500\Omega$,	5.0 ± 0.5	1.0	3.6	5.6	1.0	6.2		Figure 3
C _{IN}	Input Capacitance		0		2.5				pF	
C _{PD}	Power Dissipation	Note 3	3.3		10				pF	Figure 2
	Capacitance		5.0		12					

Notes:

3. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression:

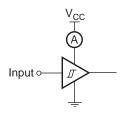
 $I_{CCD} = (C_{PD})(V_{CC})(f_{\mathsf{IN}}) + (I_{CC} static).$

AC Loading and Waveforms



 $^{\star}\text{C}_{\text{L}}$ includes load and stray capacitance. Input PRR = 1.0MHz; t_{W} = 500ns

Figure 1. AC Test Circuit



Input = AC Waveform; t_r , t_f = 1.8ns; PRR = 10MHz; Duty Cycle = 50%

Figure 2. I_{CCD} Test Circuit

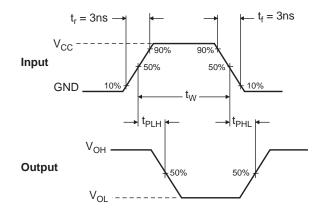


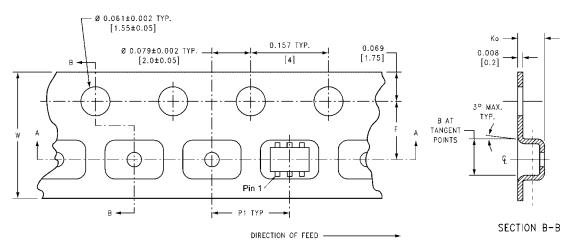
Figure 3. AC Waveforms

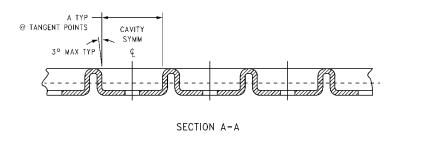
Tape and Reel Specification

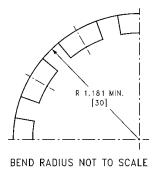
Tape Format for SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
P6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

Tape Dimension inches (millimeters)



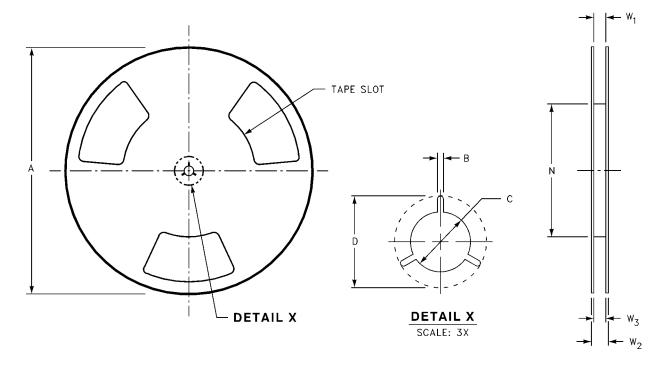




Package	Tape Size	Dim A	Dim B	Dim F	Dim K _O	Dim P1	Dim W
SC70-6	8mm	0.093	0.096		0.053 ± 0.004	0.157	0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)

Tape and Reel Specification (Continued)

Reel Dimension for MicroPak inches (millimeters)



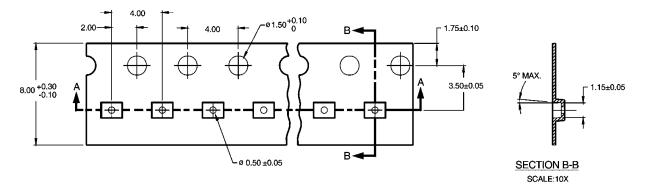
Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

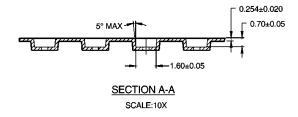
Tape and Reel Specification (Continued)

Tape Format for MicroPak

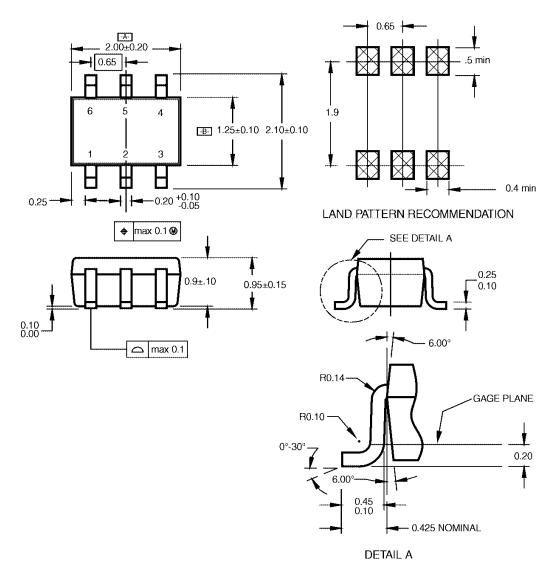
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

Tape Dimension inches (millimeters)





Physical Dimensions inches (millimeters) unless otherwise noted



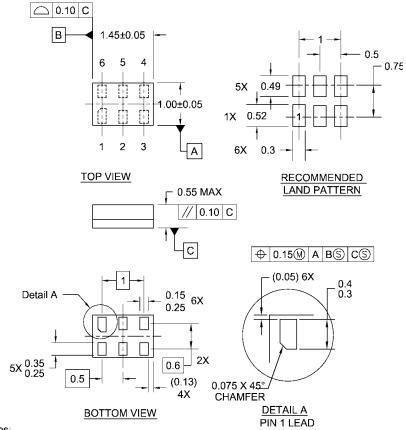
NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

MAA06ARevC

6-Lead SC70, EIAJ SC88, 1.25mm Wide Package Number MAA06A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

Pb-Free 6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

$ACEx^{TM}$	FAST®	ISOPLANAR™	PowerSaver™	SuperSOT™-6
ActiveArray™	FASTr™	LittleFET™	PowerTrench [®]	SuperSOT™-8
Bottomless™	FPS™	MICROCOUPLER™	QFET [®]	SyncFET™
Build it Now™	FRFET™	MicroFET™	QS™	TCM™
CoolFET™	GlobalOptoisolator™	MicroPak™	QT Optoelectronics™	TinyLogic [®]
CROSSVOLT™	GTO™ [']	MICROWIRE™	Quiet Series™	TINYOPTO™
DOME™	HiSeC™	MSX™	RapidConfigure™	TruTranslation™
EcoSPARK™	I ² C TM	MSXPro™	RapidConnect™	UHC™ _
E ² CMOS TM	i-Lo™	OCX TM	μSerDes™	UltraFET [®]
EnSigna™	ImpliedDisconnect™	OCXPro™	ScalarPump™	UniFET™
FACT™	IntelliMAX™	OPTOLOGIC®	SILENT SWITCHER®	VCX TM
FACT Quiet Series™		OPTOPLANAR™	SMART START™	Wire™
Across the board. Around the world. [™] The Power Franchise [®] Programmable Active Droop [™]		PACMAN™	SPM™	
		POP™	Stealth™	
		Power247™	SuperFET™	
		PowerEdge™	SuperSOT™-3	

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILDÍS PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I18